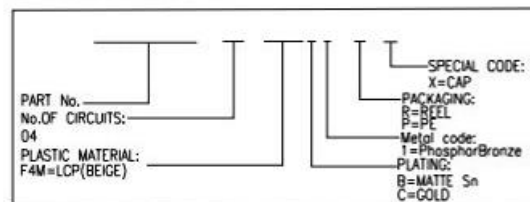


主要技术参数 Main Specifications

线 数 (Poles): 02 to 25
 接触电阻 (Contact resistance): $\leq 20m\Omega$
 绝缘电阻 (Insulation resistance): $\geq 100M\Omega$
 额定电压 (Rated voltage): 30V AC DC
 额定电流 (Rated current): 0.5A AC DC
 耐 电 压 (Withstand Voltage): 200V AC/minute
 温度范围 (Temperature Range): $-25^{\circ}C \sim +85^{\circ}C$

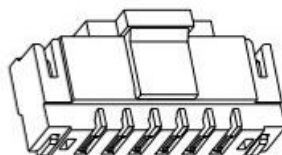
ORDER INFORMATION:



PCB LAYOUT

15	11.2	14.2			
14	10.4	13.4			
13	9.6	12.6			
12	8.8	11.8			
11	8.0	11.0	25	19.0	22.0
10	7.2	10.2	24	18.2	21.2
9	6.4	9.4	23	17.4	20.4
8	5.6	8.6	22	16.6	19.6
7	4.8	7.8	21	15.8	18.8
6	4.0	7.0	20	15.0	18.0
5	3.2	6.2	19	14.2	17.2
4	2.4	5.4	18	13.4	16.4
3	1.6	4.6	17	12.8	15.8
2	0.8	3.8	16	12.0	15.0
孔位	DIM A	DIM B	孔位	DIM A	DIM B

D	CAP		1 PCS	LCP	UL 94V-0, COLOR:BEIGE
C	Solder TAB		2 PCS	PhosphorBronze	Motte Sn
B	CONTACT		n PCS	PhosphorBronze	Motte Sn-plated/GOLD
A	HOUSING		1 PCS	LCP	UL 94V-0, COLOR:BEIGE
ITEM	COMPONENT		Q'TY	MATERIAL	FINISH



UNITS
mm

MAT'L

FINISH

Q'TY

PCS

X.± 0.3	X.°± 5'
.X± 0.25	.X'± 2'
.XX± 0.20	.XX°± 1'
.XXX± 0.10	.XXX°± 0.5'

科斯达电子科技有限公司

PART NO.(INTENDED USE) TITLE:
0.8mmPITCH 180°WAFER SMT TYPE

APPD: DWG NO.:

CHKD:

DR: HU 2016.09.28



SCALE	SHEET	REV.
1/1	1/1	A